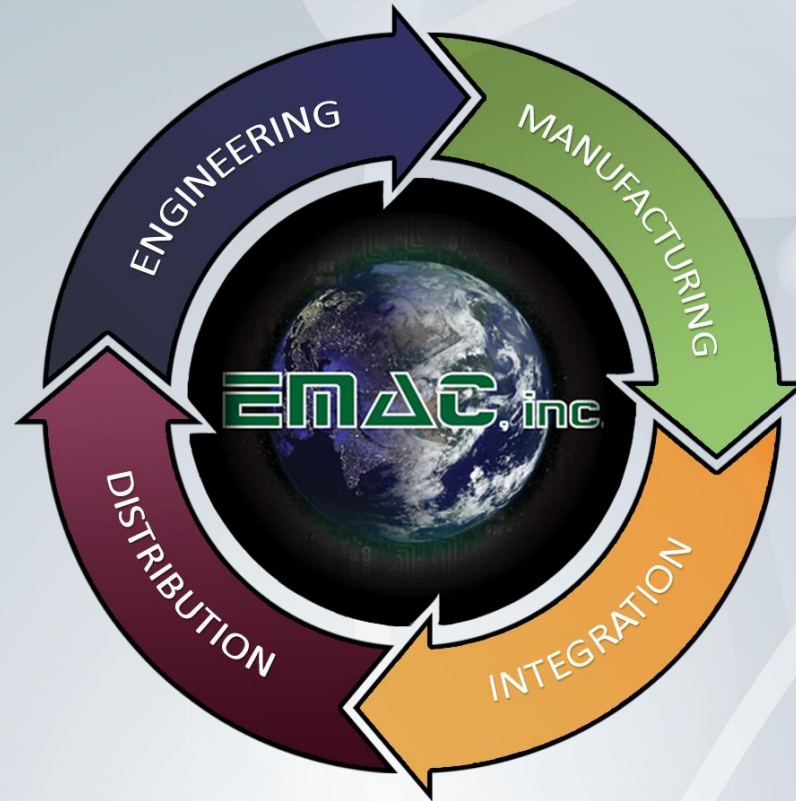


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Designing Low Power Embedded Systems

Presented by Eric Rossi
Engineering Manager
EMAC, Inc

EMAC, Inc Overview

- **Engineering Services both Software & Hardware**
- **Integration Services (Box Builds, Wiring Panels, etc.)**
- **Manufacturer of Electronic Assemblies**
- **Sale of Off-The Shelf SBCs, SOMs, PPCs, Servers**

Low Power Overview

Embedded System designers need high reliability, but also must conform to typical design constraints of low-power, long life, and extended temperature operation.

Typical Constraints-

- **Extended Product & Battery Life (5 to 10yrs)**
- **Operating at High or Low Ambient Temperatures-**
- **Operating in Harsh Environments**
- **Seasonal Battery Charging-**
- **Safety Concerns-**
- **Cost**

Low Power Overview

Presentation Topics & Case Studies

- **Low Power Considerations
(what is a low power system?)**
- **Power Sources**
- **Memories**
- **Peripherals**
- **Software**
- **Tools**
- **Microcontroller Systems**
- **Microprocessor Systems**
- **Mixed Multi-Core Systems**

Low Power Considerations

- **Low Power Considerations**
 - **Clock Frequency-**
 - **Dynamic External Oscillator (eg. SI5351A)**
 - **Crystals & Load Capacitance-**
 - **Internal RC Oscillators (varies over temperature)-**
 - **Dynamic Programmable Processor Clock**
 - **Regulators & System Voltage**
 - **Linear Regulators**
 - **Low-Dropout Regulator (LDO)**
 - **(Dynamic) Switching Regulator (efficiency)-**
 - **Undriven Inputs, Pullups & Voltage Dividers**

Low Power Considerations (cont)

- **Low Power Considerations**
 - **Caps**
 - **Avoid Aluminum Electrolytic Caps (High Leakage)-**
 - **Leakage Current can be decreased by increasing voltage rating of the Cap**
 - **Use low ESR Caps in switching circuits (switching regulators)**
 - **Minimize the number of Caps-**
 - **Use SuperCaps for Additional Power-**

Low Power Considerations (cont)

- Power Sources
 - Battery & Charging
 - Always Low Power or just when on Battery
 - Last Gasp (SuperCap or Battery)
 - Non-Rechargeable
 - Carbon Zinc (3-5 yr shelf life; poor capacity)
 - Alkaline (5-10 yr shelf life; ok capacity)
 - Lithium (10+ yr shelf life; good capacity)

Low Power Considerations (cont)

- Power Sources
 - Battery & Charging
 - Rechargeable Battery
 - NiCad (~2 yr shelf life; Temp tolerant; 1000+ cycles; Memory)
 - Nickel Metal Hydride (~3 yr shelf life; No Memory; ~800 cycles)
 - Lithium Ion (~3 yr shelf life; ~1000 cycles)
 - Lead Acid (<1 yr shelf life; ~200 cycles; wide temp)

Low Power Considerations (cont)

- **Power Sources**
 - **Battery & Charging**
 - **Smart Batteries (SMBus)**
 - **Protected Batteries**
 - **Energy Harvesting**
 - **Storage (Cap or Battery)**
 - **Types: Light, Wind, Running Water, RF, Mechanical (Kinetic), Thermal**

Low Power Considerations (cont)

- **Memories**
 - **Cache (enable or disable)**
 - **RAM**
 - **Static RAM (~5.5uW)**
 - **LP DDR Self Refresh**
 - **Flash**
 - **Serial NOR (~2x more power than Parallel NOR)**
 - **Parallel Flash - NOR (int; lower standby) & NAND**
(lower active)
 - **Managed NAND (eMMC, Thumb Drives, etc.)**
 - **FRAM/MRAM** (Non-Volatile Faster, Lower Power, expensive, lower capacity)

Low Power Considerations (cont)

- **Peripherals**
 - **Serial & CAN Ports**
 - **Ethernet**
 - **USB-**
 - **LCDs (OLED, reflective, e-paper, transmissive)-**
 - **Analog**
 - **Analog Bias Settings (reduce bias current)**
 - **References**
 - **Analog Blocks in Micros (Comparator, A/D, D/A)**
 - **Analog Switch & Relays (Pick-up vs Holding)-**

Low Power Considerations (cont)

- **Peripherals**
 - **Wireless**
 - **LANs - Low Power Local Area Networks**
(6Lowpan, Thread, Zigbee, Zwave, BLE, Wi-Fi HaLow 802.11ah)
 - **WANs - Low Power Wide Area Networks (LoRa [10 yr battery], LTE Cat-M1, NB-IoT, Sigfox)**
 - **Combo – Integrated Microcontroller & Radio**
 - **Radios and Battery Operation (Repeaters)**

Low Power Considerations (cont)

- **Peripherals**
 - **Global Positioning System** (GPS; I2C or Serial)
 - First Fix (Searching; ~35mA)
 - Tracking (~25mA)
 - Hibernate/Sleep/Standby (No RF; microamps)
 - **Autonomous Peripherals**
 - Smart Sensors (event driven)
 - Smart I2C (ADT75 Temperature & H3LIS100DL Accelerometer)
 - DMA (Sleep DMA)

Software & Tools

- **Software Techniques**
 - **Polling Loops vs Timers (idle mode)**
 - **Event Reduction (increase the number of tics when scheduling threads)**
 - **CPU Frequency (dynamic prescaling; PLLs)**
 - **I/O Line contention & I/O Line Pull-Ups**
 - **Low Power Sleep**
 - **To Sleep or not to Sleep**
 - **Going into and Coming out of Sleep**
 - **Delays**
 - **Power Restoration**
 - **Interrupt Sleep-On-Exit feature**

Software & Tools (cont)

- **Tools**

- **Energy Profilers (ULPBench)**
- **Battery Life Estimator (BLE; Microchip)**
- **EEVbog uCurrent Meter**
- **Qoitech OTII-ARC**
- **Hitex PowerScale (multi-channel but expensive)**
- **Benchmarks (used for comparing processors; CoreMark & ULPmark)**
- **ARM Mbed OS (supports Sleep modes)**
- **MicroPython (supports Sleep modes)**
- **FreeRTOS & Atollic (supports Sleep modes)**
- **Linux (Xenomi, Qt, OE, Yocto, Qt Creator; ACPI)**
- **Windows 10 (Battery Saver; ACPI)**

Low Power Microcontrollers

- **Microchip PIC**
 - **Sleep/Standby Modes (Microchip PIC)**
 - **Run Modes (Fast Run; Low Power Run – Slower Clk Source)**
 - **Idle Modes (CPU Halted; Int Wkup; Peripherals Active)**
 - **Sleep Modes (CPU Halted; Int Wkup; Limited Peripheral Operation, GPIOs continue to drive)**

Low Power Microcontrollers (cont)

- **Microchip/Atmel AVR (Arduino)**
 - **Sleep/Standby Modes**
 - **Idle Mode (Stop CPU & Flash Clocks; Int Wkup)**
 - **Power-Down (Stop EXT Osc; Single Int Wkup)**
 - **Power-Save (Same as Power-Down but Timer/Counter 2 continues to run)**
 - **Standby (Same as Power-Down but CPU Clock is kept running; fast wakeup)**
 - **Extended Standby (Same as Power-Save but CPU Clock is kept running; fast wakeup)**

Low Power Microcontrollers (cont)

- ARM – M0, M3, M4
 - Sleep/Standby Modes (Silicon Labs ARM Cortex M)
 - EM0 - Run/On
 - EM1 - Sleep (No CPU Clock)
 - EM2 - Deep Sleep (Slow Clock – 32KHz)
 - EM3 - Stop (Interrupt wakeup)
 - EM4 - Shutoff (Reset wakeup)

Low Power Microcontrollers (cont)

- **General Low Power Selection Criteria**
 - **Minimize the number of I/O pins**
 - **Minimize the number of internal peripherals**
 - **Verify that a low-power timer is included on the MCU**
 - **Make sure that a DMA controller is included**
 - **Pay attention to Sleep Modes**

Low Power Microprocessors

- **ARM**

- ARM9 (older & slower but less leakage)
- ARM Cortex A5
- ARM Cortex A7
- ARM Cortex A32

- **X86**

- Vortex (DMP)
 - SX, DX, DX2, EX, DX3
(~1 watt for DX; ~4 watts for a DX system)
- Atom
- i3

Low Power Microprocessors (cont)

- **Sleep/Standby Modes (APM/ACPI)**
 - **Run/On**
 - **Idle mode (System Idle Process; Automatically enters Standby)**
 - **Standby (Partial Clock; Subsystems in LP mode; RAM active)**
 - **Slow Clock Mode (APM Sleep; Slow Clock 32khz; RAM Self Refresh)**
 - **Suspend (Suspend to RAM; Deep Sleep; No Clock; Long Restore Time)**
 - **Hibernate (Suspend to Disk; Long Restore Time)**
 - **Stop/ Off**

Low Power Microprocessors (cont)

- Utilization of PLD or Low Power Coprocessor
 - Shared Memory & DMA
 - Buffering
 - Power Management
- Mixed Multi-Core Technology
 - TI ARM Cortex A8 & Programmable Real Time Unit (PRU) (eg. AM335x)
 - NXP ARM Cortex A & Cortex M (eg. i.MX6 SoloX)

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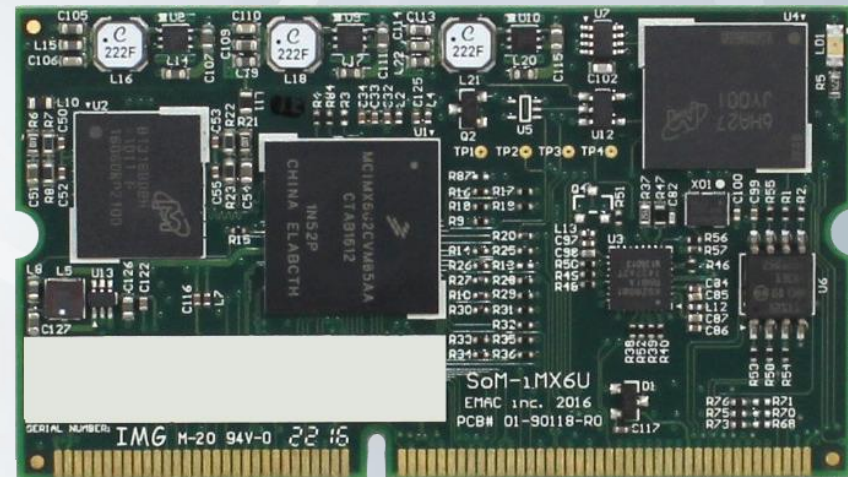
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Case Study #1 ([Back ->](#))

SoM-IMX6U System on Module

- Power Source 3.3v
- NXP i.MX 6 Ultralight ARM Cortex A7 Processor
- Dynamic Core Regulation
- ~ 2.5mA in APM Slow Clock Mode (32KHz)
- ~ 130ms to come out of sleep
- Ethernet & CAN Connectivity
- Linux OS



Case Study #2

Windows Industrial Tablet

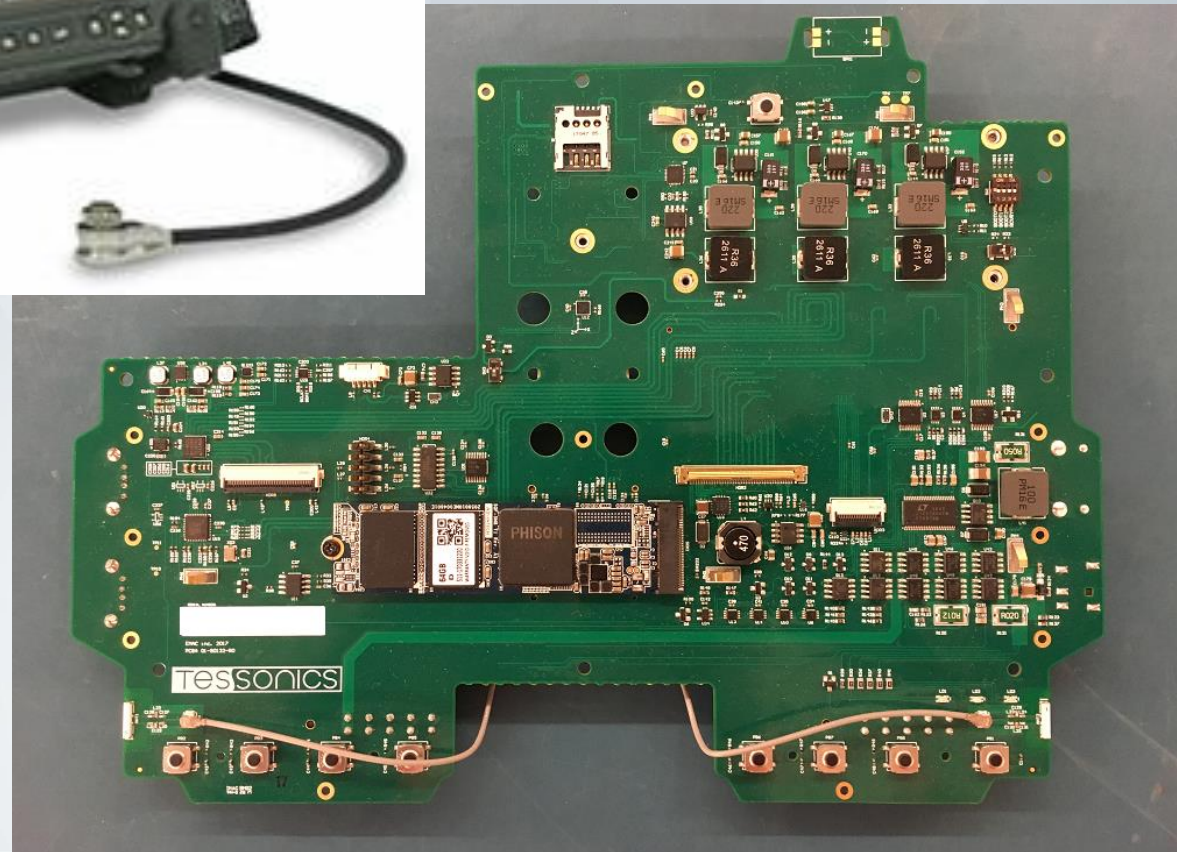
- **Power Source**
 - **19.2 Vdc Laptop Power Supply**
 - **2x Smart 14.4 Vdc Li Ion batteries (hot swap)**
- **ST Micro ARM M4 Coprocessor (power management)**
- **Intel E3900 Atom SMARC SOM based**
- **APM Power Management**
- **Windows 10 Embedded OS**
- **Wifi & Bluetooth Connectivity via PCIe Module**

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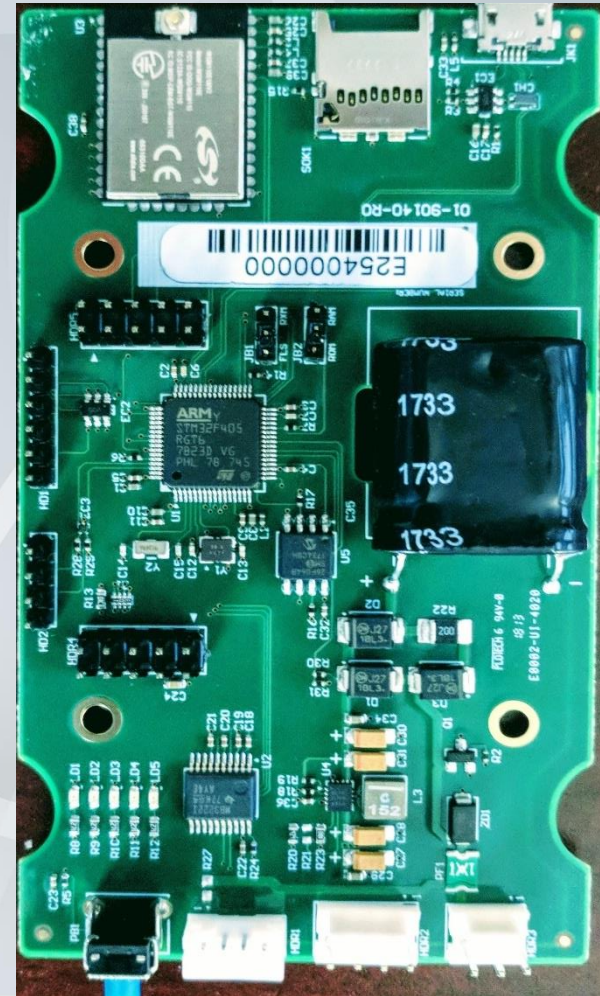
Case Study #2

[\(Back ->\)](#)



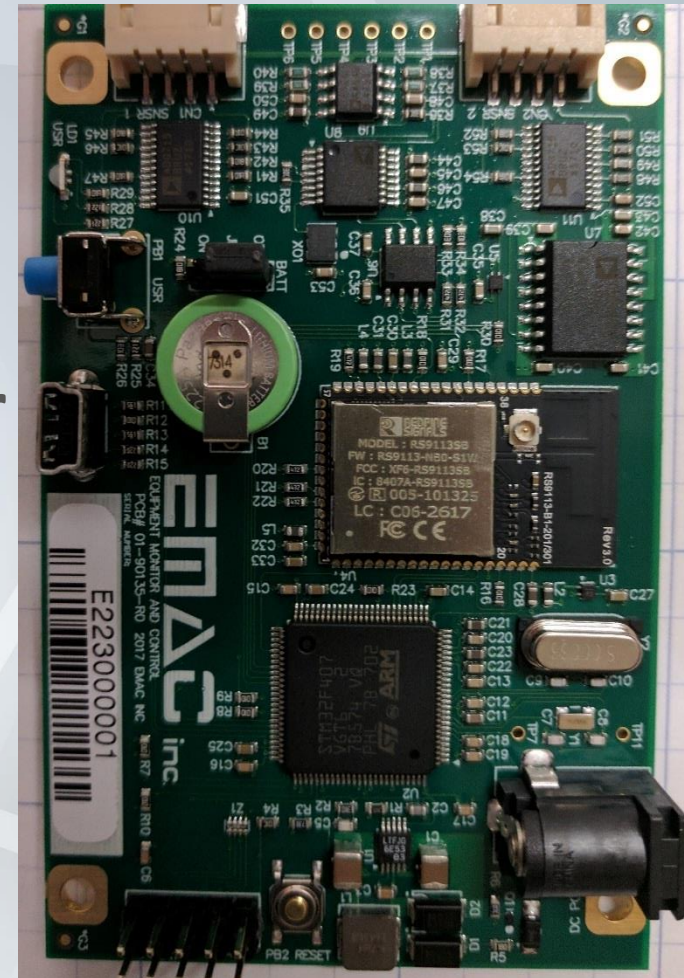
Case Study #3 ([Back ->](#)) Wifi Communication Module

- Power Source
 - 5 Vdc Supply
- SuperCap (2.5F) for Last Gasp (~15 Seconds @ ~250mA)
- ST Micro ARM Cortex M4 Processor
- FreeRTOS OS
- Wifi Connectivity (Silicon Labs)



Case Study #4 ([Back ->](#)) Water Purity Device

- Power Source
 - 12V Wall Power Supply
 - Non-Rechargeable Battery (6x AA Cell battery pack)
- ST Micro ARM Cortex M4 Processor
- MicroPython OS
- Wifi & Bluetooth Radios (Redpine)
- IBM Bluemix Cloud
- 3 Independent Power Modes
 - Processor, Radio, Analog Sleep



Case Study #5

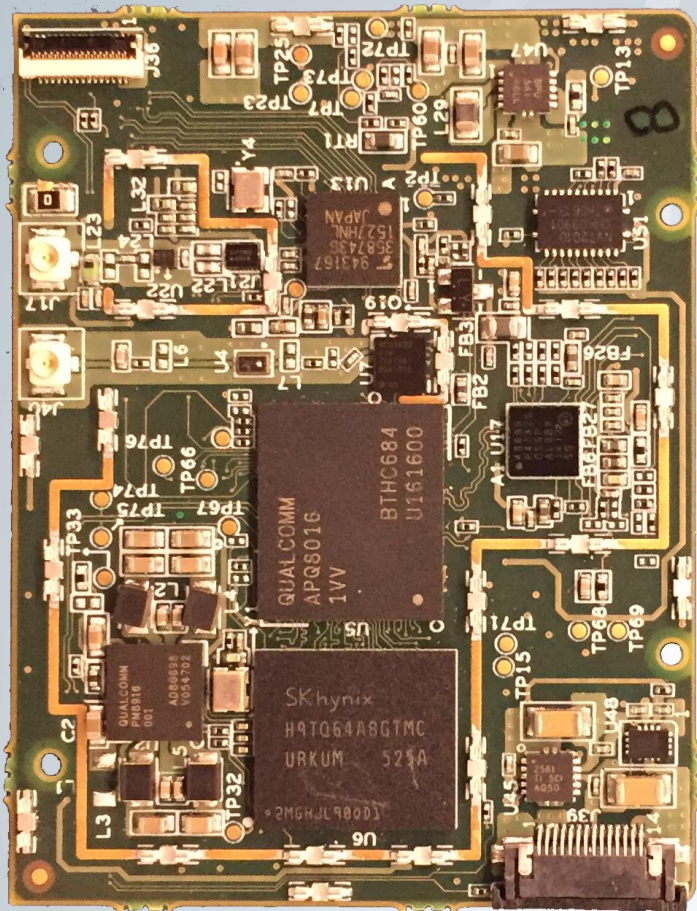
Automated Camera Tracking System

- **Power Source**
 - **3.5 Vdc Lithium Ion Battery (x4 in parallel)**
 - **USB 5Vdc alternate power and charging**
- **Qualcomm Snapdragon 410E ARM A53 64-bit processor**
- **Camera Interface**
- **Wifi & Bluetooth Connectivity**
- **Android Embedded OS**

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Case Study #5 ([Back ->](#)) Automated Camera Tracking System



Case Study #6

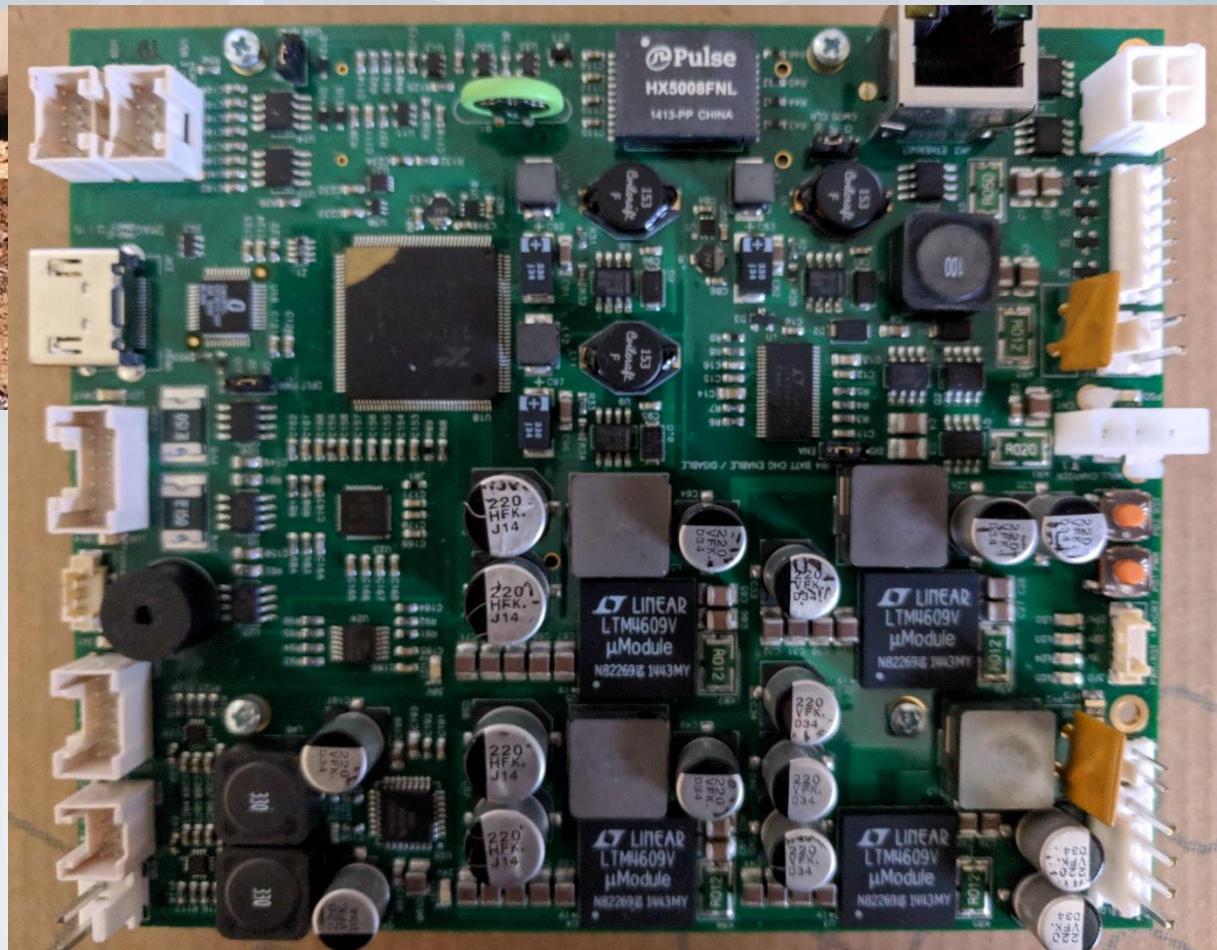
Medical Patient Simulator

- **Power Source**
 - **19.2 Vdc Laptop Power Supply**
 - **2x Smart 14.4 Vdc Li Ion batteries (hot swap)**
 - **LTC1760 Dual Smart Battery Manager**
- **Intel E3845 Atom COM Express SOM based**
- **APM Power Management**
- **Linux Embedded OS (EMAC OE 5.0)**
- **1000 BaseT & Wifi Connectivity**
- **8 Regulators (1.5v, 3.3v, 2x 5v buck, 3.3v LDO, 24v Boost, 2x 12v Boost/Buck)**

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Case Study #6 ([Back ->](#)) Medical Patient Simulator



Case Study #7 ([Back ->](#)) Ambient Ear Buds

- **Power Source**
 - Rechargeable Battery 3.3v Lithium Ion (with protection)
 - 5v (USB; for power and charging)
- ST Micro M0 Power Management & Control Processor
- CSR Bluetooth Radio
- Analog Device DSP



Case Study #8

Artic Glacier Monitor

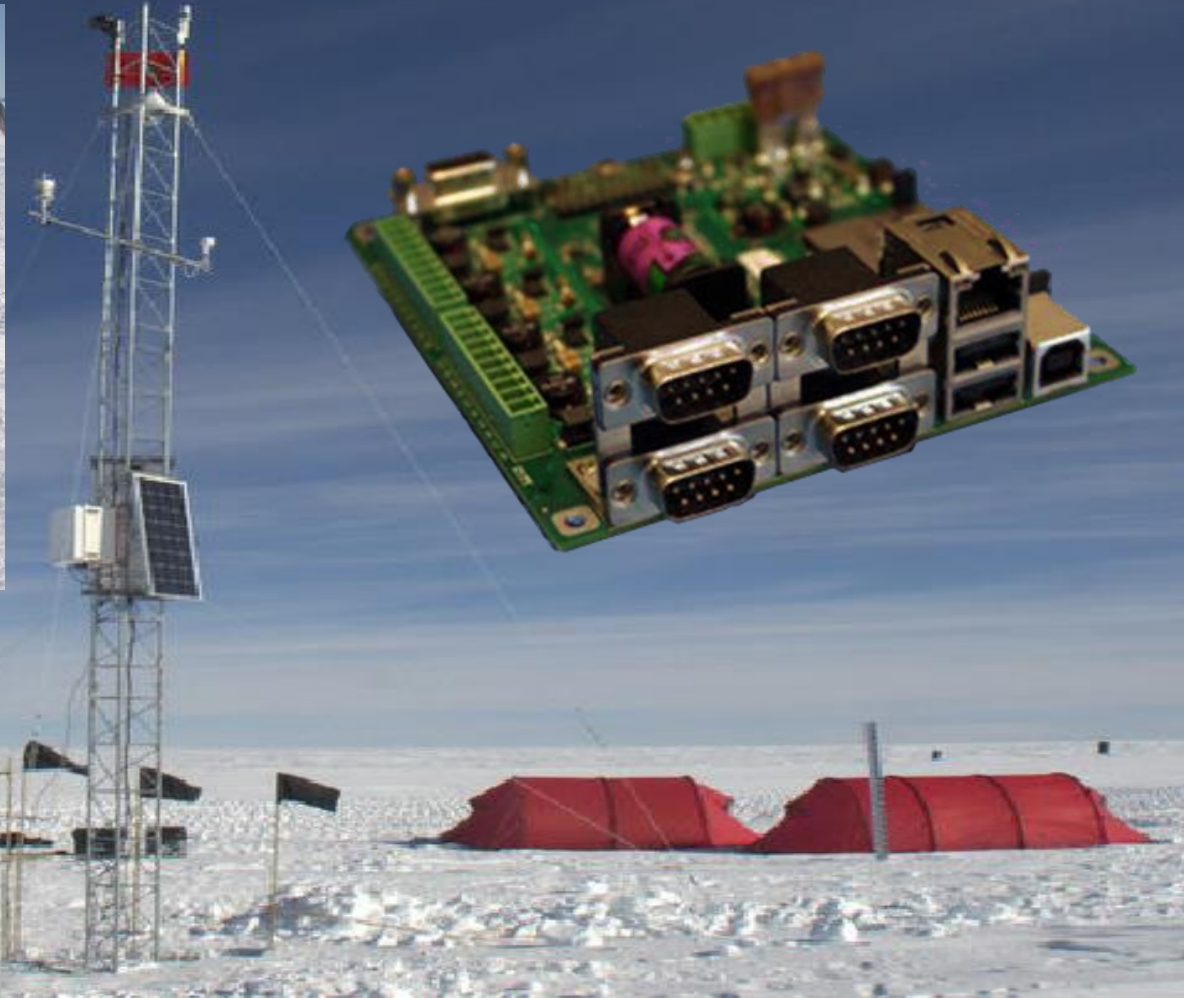
- **Power Source**
 - **Rechargeable Battery 12v Lead Acid (Gel Cell)**
 - **Solar Energy Harvesting**
 - **~3.2mA in Sleep**
- **SoM-9260 (AT91SAM9260) & SoM-IMX6U (IMX6UL)**
- **Microchip PIC Power Management & Watchdog Proc.**
- **Satellite Radio**
- **USB Camera**
- **Magnetostrictive, Accelerometer, Pressure, Temperature, Humidity Sensors**
- **5 Serial Ports & CAN**

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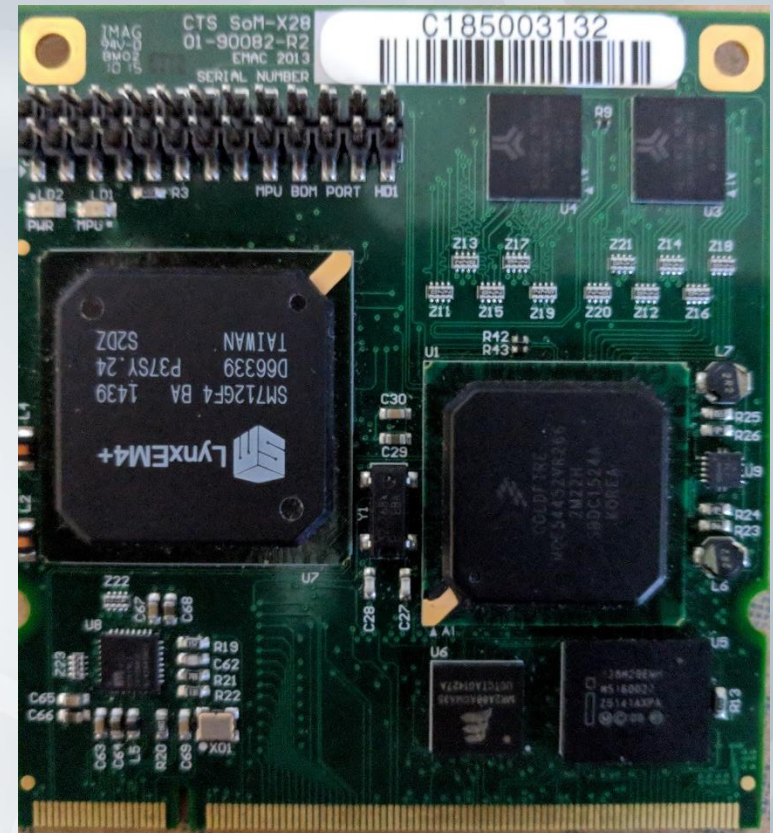
Case Study #8 ([Back ->](#)) Arctic Glacier Monitor



Case Study #9 ([Back ->](#))

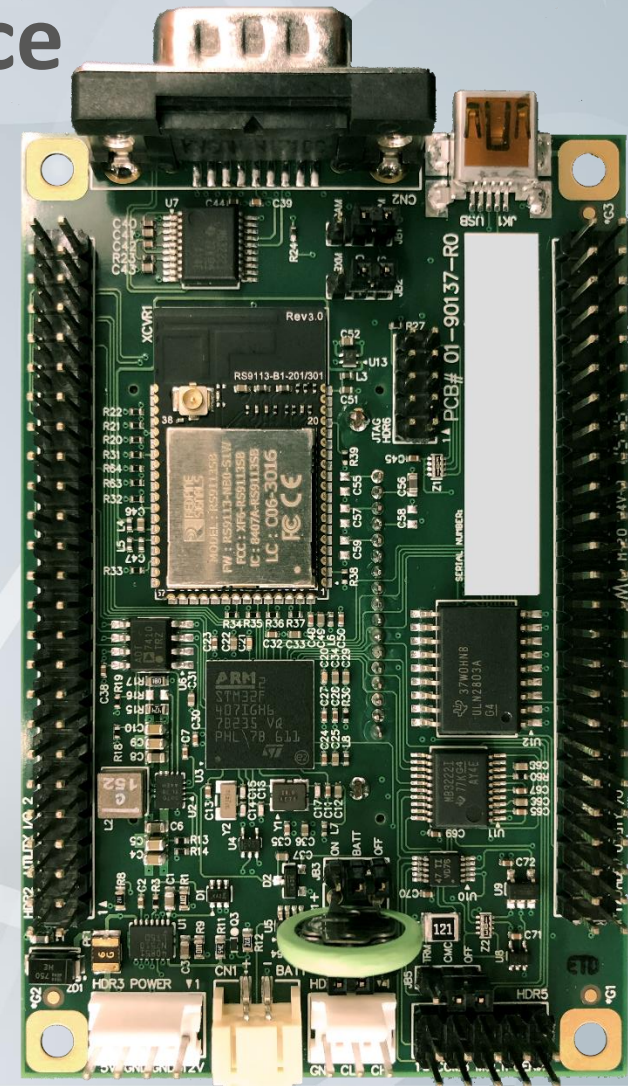
Custom System on Module (SoM)

- Power Source
 - 3.3v
- Coldfire Processor
- Lynx PCI Video Controller
- Linux OS
- MRAM (4Mb; Everspin)
- USB
- Ethernet & CAN Connectivity



Case Study #10 ([Back ->](#)) CutiPy™ IoT Device

- Power Source
 - 5V Power Supply or USB
 - 3.8v rechargeable Li-Ion battery (LT4085 Battery Power Manager)
- ST Micro ARM Cortex M4 Processor
- MicroPython or Free RTOS OS
- Bluetooth, Zigbee, Thread & Wifi
- Graphic LCD & Pushbuttons



Case Study #11 ([Back ->](#)) Electric Vehicle Charging Station

- **Power Source**
 - **5v Power Supply**
- **SoM-9G45 Module (AT91SAM9G45)**
- **Linux OS**
- **Cell Modem (Telit; 3g LTE)**
- **Wifi (Wi2Wi)**
- **TPM (Trusted Platform Module) Chip
(high security application)**



Case Study #12 ([Back ->](#)) Emergency Vehicle Location Device

- Power Source
 - 9v – 15v Vehicle Power Supply (Alternator)
 - 12v Vehicle Battery
- ST Micro ARM Cortex M4 Proc.
- MicroPython OS
- Cell Modem (Telit 4g LTE)
- GPS Location
- Amazon AWS Cloud



Case Study #13

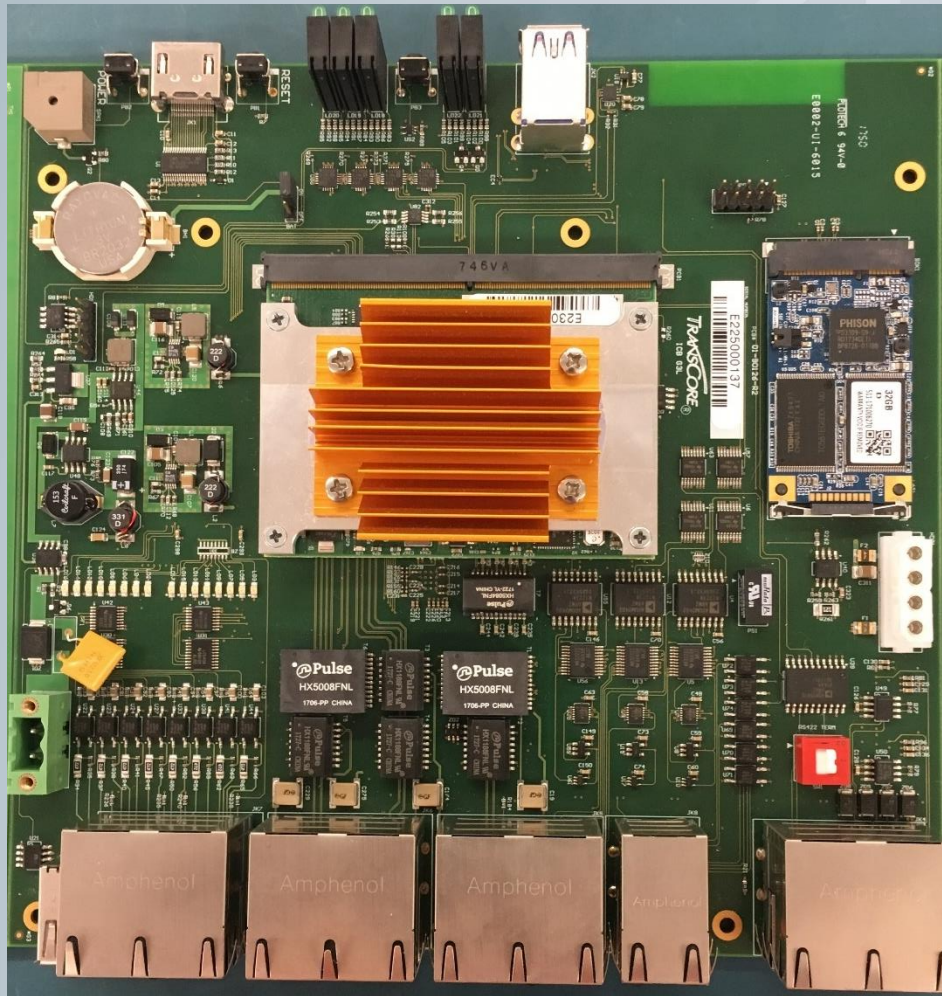
Open Road Tolling (ORT) System

- **Power Source**
 - **12vdc Power Supply**
- **SoM-IMX6M ARM A9 Dual Core Module**
- **Linux OS with Xenomai Real Time Extensions**
- **2 Ethernets with 6 Port on board Switch & CAN Connectivity**
- **PIC 12F635 ATX Power Management Coprocessor (~12uA in sleep; wakes up every 90 sec to reset timer)**
- **Replaces a Atom based solution with active cooling**

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Case Study #13 ([Back ->](#)) Open Road Tolling (ORT) System



Case Study #14 ([Back ->](#))

Gas & Water Metering System

- Power Source
 - 12.0 vdc Power Supply
 - 12.6 vdc Lead Acid (Gel Cell) Standby Battery
- SoM-9260 ARM9 Module
- Altera PLD for Pulse Counting (< 150uA in Standby)
- Ethernet & Cell Modem Connectivity
- Over 30 days on Standby Battery
- Linux OS



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Case Study #15 ([Back ->](#))

SoM-3354 System on Module

- Power Source 3.3v
- TI AM3354/3357 ARM Cortex A9 Processor
- Programmable Real Time Unit (PRU) / Industrial Communication SubSystem (ICSS; PRU-ICSS)
- EtherCAT
- PROFIBUS/PROFINET RT/IRT
- HSR/PRP
- Ethernet & CAN Connectivity
- Linux OS



Figure #1 ([Back ->](#))

Fig. 1 Comparison of NOR and NAND Flash

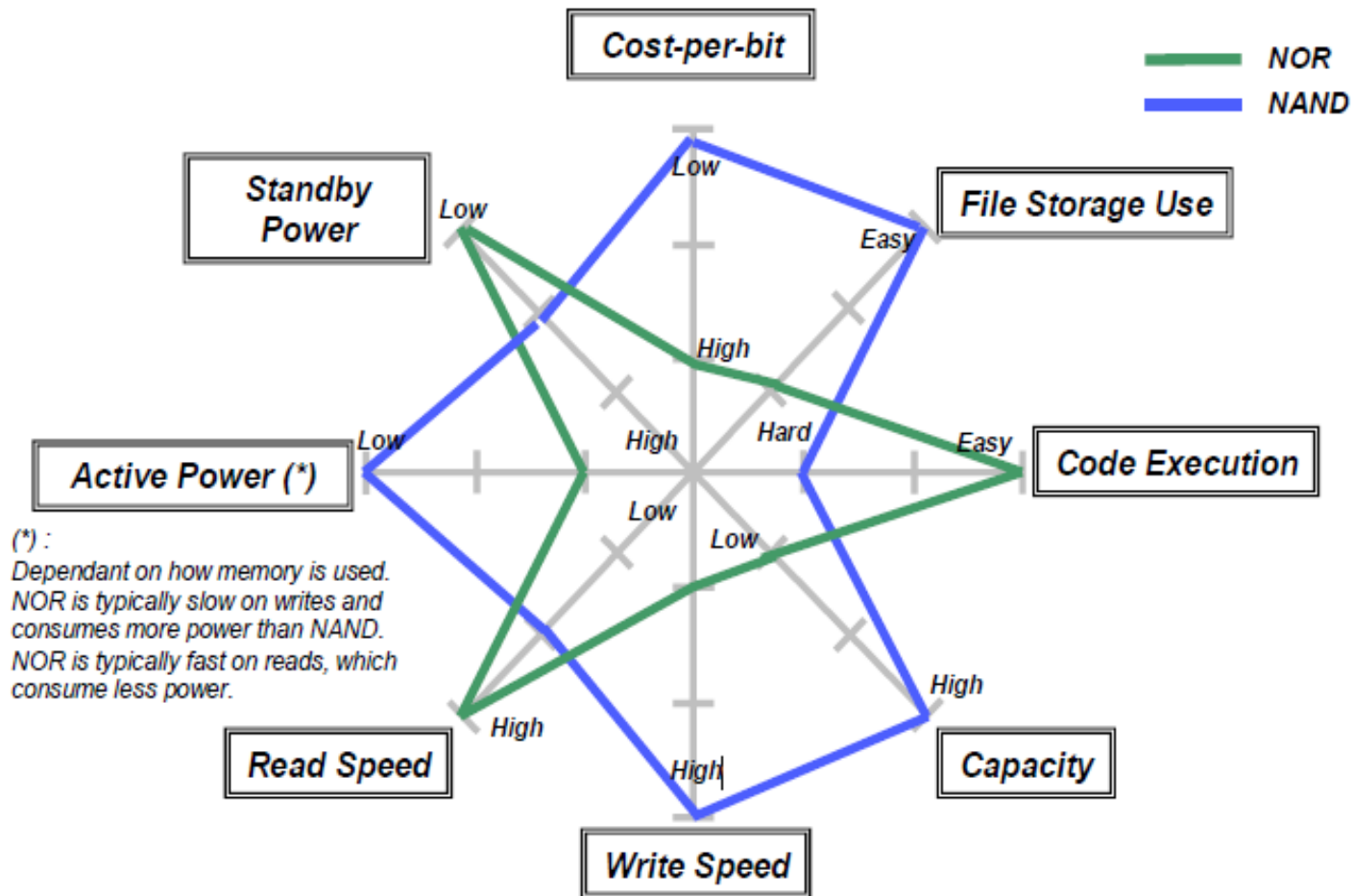


Figure #2 ([Back ->](#))

	Wi-Fi HaLow	Bluetooth low energy (5)	ZigBee	Thread	Sub-GHz IEEE 802.15.4
Max. data throughput	347 Mbps	2 Mbps	250 kbps	250 kbps	100 bps
Max. line-of-sight range*	N/A ¹	750 m	130 m	100 m ⁷	4000 m
Power consumption	N/A ²	Years from a coin cell	Years from a coin cell	Years from a coin cell	Years from a coin cell ⁸
Mesh networking	Yes	Yes ⁴	Yes	Yes	No
IP at the device node	Yes	Yes ⁵	No	Yes	No
OC/mobile OS support	Yes	Yes	No	No	No
Infrastructure in place	Yes, routers ³	Yes, mobiles ⁶	No	No	No

1. Said to be greater than Bluetooth 5

2. Said to be comparable with Bluetooth 5

Figure #3 ([Back ->](#)) Silicon Labs Energy Modes

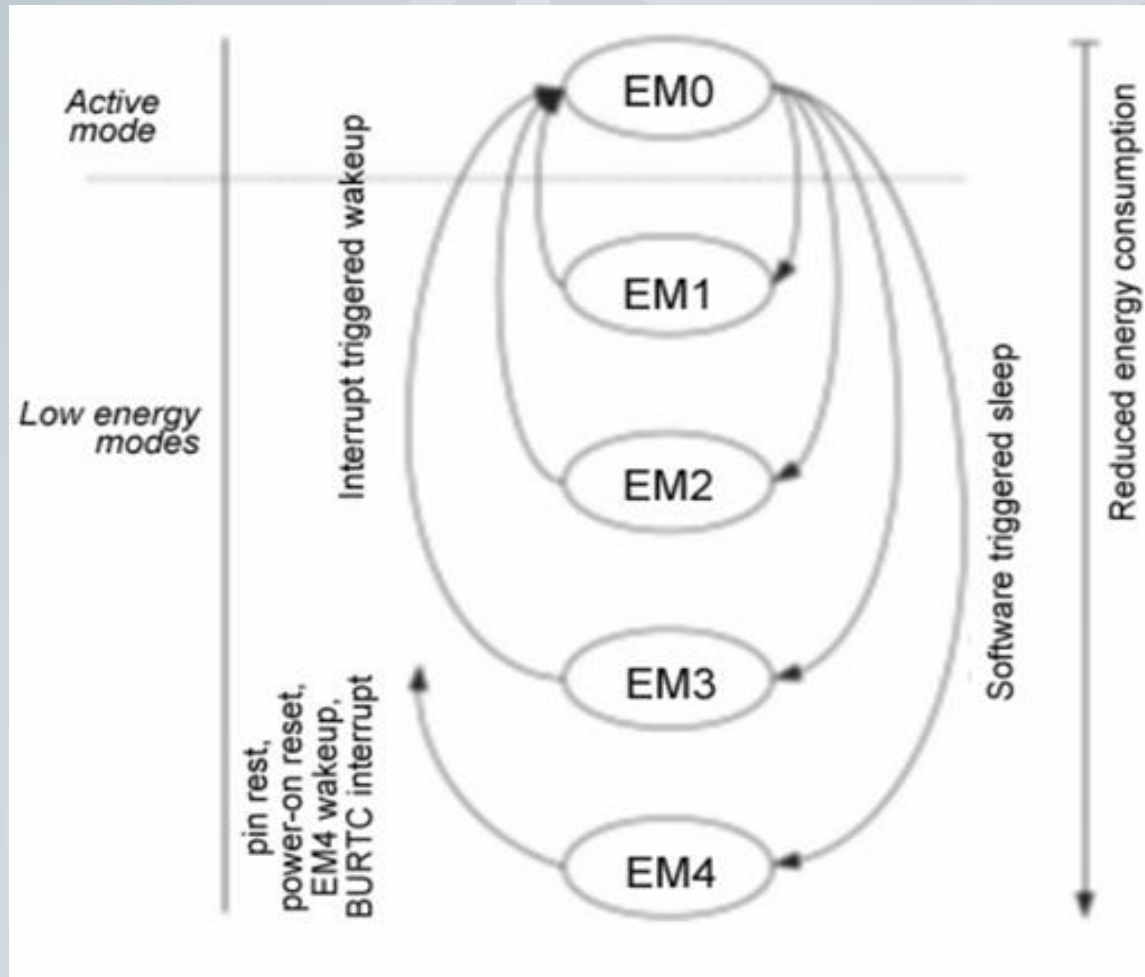
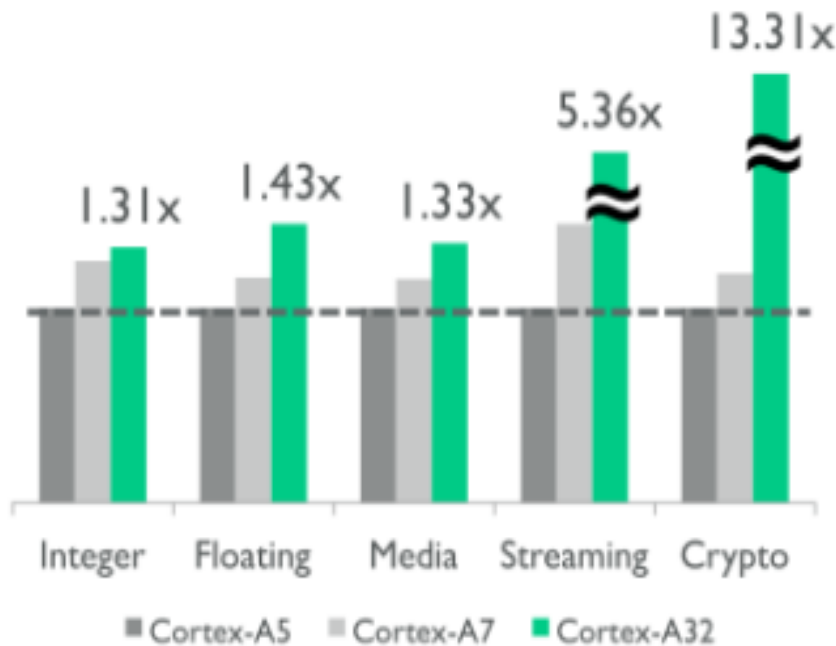


Figure #4 ([Back ->](#))

- Higher performance than Cortex-A5 and Cortex-A7
- Same performance as Cortex-A35



Efficiency Improvement

- >25% vs. Cortex-A7
- >30% vs. Cortex-A5
- >10% vs. Cortex-A35

Figure #5 ([Back ->](#))

Comparison of ARM, Atom, i7

	Cortex A15 (no L2, 32nm)	Cortex A9 (no L2, 40nm)	Atom N270 (45nm)	i7 960 (45nm)
Number of Cores	2 (4 maximum)	2 (4 maximum)	1 Core, 2 HT threads	4 Cores, 8 HT threads
Frequency	1Ghz – 2.5 Ghz	800Mhz (Po) 2Ghz (Per)	1.6 Ghz	3.2 Ghz
Out-of-Order?	Yes	Yes	No	Yes
L1 cache size	32KB I/D	32KB I/D	32KB I/D	32KB I/D
L2 cache size	N/A	N/A	512KB	1MB + 8MB L3
Issue Width	4	4	2	4?
Pipeline Stages	?	8	16	14 ~ 24 (?)
Supply Voltage	?	1.05V (Per)	0.9 – 1.1625 V	0.8-1.375 V
Transistor Count	?	26,00,000?	47,000,000	731,000,000
Die size	?	4.6 mm ² (Po) 6.7 mm ² (Per)	26 mm ²	263 mm ²
Power Consumption	?	0.5 W (Po) 1.9 W (Per)	2.5W (TDP)	130W (TDP)